P-Channel Enhancement Mode Field Effect Transistor

Description

The ATM1205PSI uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications. Standard Product ATM1205PSI is Pb-free.

Feature

- ◆ V_{DS} (V) = -12V
- ◆ I_D = -1.7 A (V_{GS} = -4.5V)
- $R_{DS(ON)} < 100 m\Omega (V_{GS} = -4.5V)$
- R_{DS(ON)} < 130mΩ (V_{GS} = -3.6V)
- $R_{DS(ON)} < 150 m\Omega (V_{GS} = -2.5V)$
- RDS(ON) < 250mΩ (VGS = -1.8V)</p>



Absolute Maximum Ratings (T _A =25°C, unless otherwise noted)								
Parameter		Symbol	Maximum		Units			
Drain-Source Voltage		V _{DS}	-12		V			
Gate-Source Voltage		V _{GS}	±12		V			
Continuous Drain Current NOET 1	T _A =25°C	l _D	-1.7					
	T _A =70°C		-1.4		A			
Pulsed Drain Current NOET 2		I _{DM}	-20		A			
	T _A =25°C	PD	0.47					
Power Dissipation NOET	T _A =70°C		0.30		VV			
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150		°C			
Thermal Characteristics								
Parameter		Symbol	Тур	Мах	Units			
Maximum Junction-to-Ambient NOET 1	t≤ 10s		215	265	°C/W			
Maximum Junction-to-Ambient NOET 1	Steady-State	R _{eja}	240	300	°C/W			
Maximum Junction-to-Lead NOET 3	Steady-State	R _{eJL}	105	130	°C/W			



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Dated:10/2019 Rev: 1.0

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Electrical Characteristics (T _A =25°C unless otherwise noted)								
Parameter	Symbol	Conditions	Min	Тур	Мах	Units		
Static Characteristics								
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =-250µA, V _{GS} =0V	-12			V		
Zero Gate Voltage Drain Current	ldss	V _{DS} =-9.6V, V _{GS} =0V			-1	μA		
Gate-Body leakage current	lgss	V_{DS} =0V, V_{GS} =±12V			±100	nA		
Gate Threshold Voltage	VGS(th)	Vds=Vgs, Id=-250µA	-0.45	-0.75	-1.0	V		
	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-1.7A		75	100	mΩ		
		V _{GS} =-3.6V, I _D =-1.0A		80	130	mΩ		
Static Drain-Source On-Resistance		V _{GS} =-2.5V, I _D =-1.0A		103	150	mΩ		
		V _{GS} =-1.8V, I _D =-0.6A		150	250	mΩ		
Forward Transconductance	g fs	V _{DS} =-1.8V, I _D =-1.0A		4.8		S		
Diode Forward Voltage	V _{SD}	I _S =-1.0A,V _{GS} =0V		-0.85	-1.2	V		
Dynamic Characteristics	1							
Input Capacitance	Ciss			618		pF		
Output Capacitance	Coss	V _{GS} =0V, V _{DS} =-10V,		172		pF		
Reverse Transfer Capacitance	C _{rss}	f=100KHz		134		pF		
Switching Characteristics								
Total Gate Charge	Qgtot			8.7		nC		
Gate Source Charge	Q _{gs}	V _{GS} =-4.5V, V _{DS} =-10V,		1.5		nC		
Gate Drain Charge	Q _{gd}	I _D =-1.7A		2.9		nC		
Turn-On Delay Time	td(on)			15.8		ns		
Turn-On Rise Time	tr	Vcs=-4.5V Vpp=-10V		19.8		ns		
Turn-Off Delay Time	td(off)	Id=-1.7А. Rgen=60		92.4		ns		
Turn-Off Fall Time	tf			139.6		ns		

Note:

The value of R_{θJA} is measured with the device mounted on 1in ² FR-4 board with 2oz. Copper, in a still air environment withT_A =25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

- 2. Repetitive rating, pulse width limited by junction temperature.
- 3. The R_{BJA} is the sum of the thermal impedence from junction to lead R $_{BJL}$ and lead to ambient.
- 4. The static characteristics in Figures 1 to 6 are obtained using 80 µs pulses, duty cycle 0.5% max.
- 5. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}$ C. The SOA curve provides a single pulserating.



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RATINGS AND CHARACTERISTIC CURVES





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Figure 11: Normalized Maximum Transient Thermal Impedance



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Package Outline Dimension (Units: mm)

SOT-323



Recommended Soldering Footprint



Packing information

Package	Tape Width (mm)	Pitch		Reel Size			
		mm	inch	mm	inch	Per Reel Packing Quantity	
SOT-323	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000	



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